

THC63LVDM83D

REDUCED SWING LVDS 24Bit COLOR HOST-LCD PANEL INTERFACE

General Description

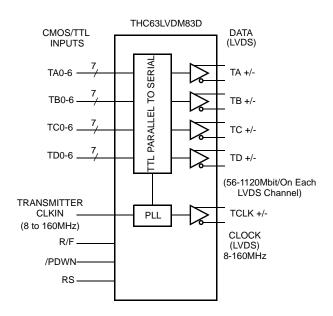
The THC63LVDM83D transmitter is designed to support pixel data transmission between Host and Flat Panel Display from NTSC up to 1080p(60Hz).

The THC63LVDM83D converts 28bits of CMOS/TTL data into LVDS(Low Voltage Differential Signaling) data stream. The transmitter can be programmed for rising edge or falling edge clocks through a dedicated pin. At a transmit clock frequency of 160MHz, 24bits of RGB data and 4bits of timing and control data (HSYNC, VSYNC, CNTL1, CNTL2) are transmitted at an effective rate of 1120Mbps per LVDS channel.

Features

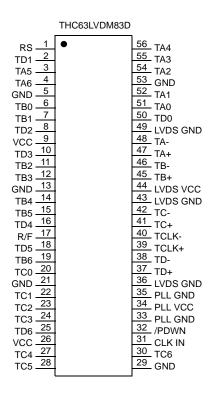
- Wide dot clock range: 8-160MHz suited for NTSC, VGA, SVGA, XGA,SXGA and SXGA+
- PLL requires no external components
- Supports spread spectrum clock generator
- On chip jitter filtering
- Clock edge selectable
- · Supports reduced swing LVDS for low EMI
- Power down mode
- Low power single 3.3V CMOS design
- Low profile 56 Lead TSSOP Package
- 1.2 up to 3.3V tolerant data inputs to connect directly to low power, low voltage application and graphic processor.
- Pin compatible with THC63LVDM83C/83R(24bits)

Block Diagram





Pin Out





Pin Description

Pin Name	Pin #	Туре	Description			
TA+, TA-	47, 48	LVDS OUT				
TB+, TB-	45, 46	LVDS OUT	LVDC Data Out			
TC+, TC-	41, 42	LVDS OUT	LVDS Data Out.			
TD+, TD-	37, 38	LVDS OUT				
TCLK+, TCLK-	39, 40	LVDS OUT	LVDS Clock Out.			
TA0 ~ TA6	51, 52, 54, 55, 56, 3, 4	IN				
TB0 ~ TB6	6, 7, 11, 12, 14, 15, 19	IN	Pixel Data Inputs.			
TC0 ~ TC6	20, 22, 23, 24, 27, 28, 30	IN	Fixer Data Inputs.			
TD0 ~ TD6	50, 2, 8, 10, 16, 18, 25	IN				
/PDWN	32	IN	H: Normal operation, L: Power down (all outputs are Hi-Z)			
RS	1	IN	RS LVDS Small Swing Input Support VCC 350mV N/A 0.6 ~ 1.4V 350mV RS=VREFa GND 200mV N/A a. VREF is Input Reference Voltage.			
R/F	17	IN	Input Clock Triggering Edge Select. H: Rising edge, L: Falling edge			
VCC	9, 26	Power	Power Supply Pins for TTL inputs and digital circuitry.			
CLKIN	31	IN	Clock in.			
GND	5, 13, 21, 29, 53	Ground	Ground Pins for TTL inputs and digital circuitry.			
LVDS VCC	44	Power	Power Supply Pins for LVDS Outputs.			
LVDS GND	36, 43, 49	Ground	Ground Pins for LVDS Outputs.			
PLL VCC	34	Power	Power Supply Pin for PLL circuitry.			
PLL GND	33, 35	Ground	Ground Pins for PLL circuitry.			



Absolute Maximum Ratings 1

Supply Voltage (V _{CC})	-0.3V ~ +4.0V
CMOS/TTL Input Voltage	-0.3V ~ (V _{CC} + 0.3V)
CMOS/TTL Output Voltage	-0.3V ~ (V _{CC} + 0.3V)
LVDS Transmitter Output Voltage	-0.3V ~ (V _{CC} + 0.3V)
Output Current	continuous
Junction Temperature	+125°C
Storage Temperature Range	-55°C ~ +150°C
Reflow Peak Temperature / Time	+260°C / 10sec.
Maximum Power Dissipation @+25°C	1.8W

^{1. &}quot;Absolute Maximum Ratings" are those valued beyond which the safety of the device can not be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.



Electrical Characteristics CMOS/TTL DC Specifications

 $V_{CC} = 3.0V \sim 3.6V$, $Ta = 0 ^{\circ}C \sim +70 ^{\circ}C$

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{IH}	High Level Input Voltage	RS=VCC or GND	2.0		V _{CC}	V
V _{IL}	Low Level Input Voltage	RS=VCC or GND	GND		0.8	V
V _{DDQ} ¹	Small Swing Voltage		1.2		2.8	V
V _{REF}	Input Reference Voltage	Small Swing (RS=V _{DDQ} /2)		V _{DDQ} /2		
V _{SH} ²	Small Swing High Level Input Voltage	$V_{REF} = V_{DDQ}/2$	V _{DDQ} /2 +100mV			V
V _{SL} ²	Small Swing Low Level Input Voltage	$V_{REF} = V_{DDQ}/2$			V _{DDQ} /2 -100mV	V
I _{INC}	Input Current	$0V \le V_{IN} \le V_{CC}$			±10	μА

Notes: $^{1}V_{DDQ}$ voltage defines max voltage of small swing input. It is not an actual input voltage. 2 Small swing signal is applied to TA0-6,TB0-6,TC0-6,TD0-6 and CLKIN.

LVDS Transmitter DC Specifications

 $V_{CC} = 3.0 V \sim 3.6 V$, $Ta = 0 ^{\circ}C \sim +70 ^{\circ}C$

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Units
VOD	Differential Output Voltage	RL=100Ω	Normal swing RS=V _{CC}	250	350	450	mV
VOD			Reduced swing RS=GND	100	200	300	mV
ΔVOD	Change in VOD between complementary output states					35	mV
VOC	Common Mode Voltage	RL=100Ω		1.125	1.25	1.375	V
ΔVOC	Change in VOC between complementary output states					35	mV
I _{OS}	Output Short Circuit Current	VOUT=0V, RL=100 Ω				-24	mA
loz	Output TRI-STATE Current	/PDWN=0V,				±10	μΑ
l _{OZ}	Output Tivi-OTATE Guitein	V_{OUT} =0V to V_{CC}				±10	μΛ



Supply Current

 $V_{CC} = 3.0V \sim 3.6V$, $Ta = 0 ^{\circ}C \sim +70 ^{\circ}C$

Symbol	Parameter	Condition(*)			Max.	Units
	Transmitter Supply Current	RL=100Ω,CL=5pF	f=85MHz	61	67	mA
		V_{CC} =3.3V, RS= V_{CC}	f=135MHz	77	83	mA
I _{TCCW}		Worst Case Pattern	f=160MHz	84	92	mA
		RL=100Ω,CL=5pF	f=85MHz	50	56	mA
		V _{CC} =3.3V, RS=GND	f=135MHz	65	71	mA
		Worst Case Pattern f=160MHz		73	80	mA
I _{TCCS}	Transmitter Power Down Supply Current	/PDWN = L, All Inputs		10	μА	

Worst Case Pattern

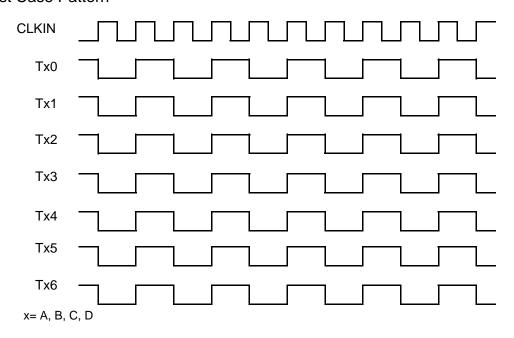


Fig1. Worst Case Pattern



Switching Characteristics

 $V_{CC} = 3.0 V \sim 3.6 V$, $Ta = 0 ^{\circ}C \sim +70 ^{\circ}C$

	100 0.01, 10 0 0					
Symbol	Parameter	Min.	Тур.	Max.	Units	
t _{TCIT}	CLK IN Transition time			5.0	ns	
t _{TCP}	CLK IN Period	6.25	Т	125	ns	
t _{TCH}	CLK IN High Time	0.35T	0.5T	0.65T	ns	
t _{TCL}	CLK IN Low Time	0.35T	0.5T	0.65T	ns	
t _{TCD}	CLK IN to TCLK+/- Delay		3T		ns	
t _{TS}	TTL Data Setup to CLK IN	2.0			ns	
t _{TH}	TTL Data Hold from CLK IN	0.0			ns	
t _{LVT}	LVDS Transition Time		0.6	1.5	ns	
t _{TOP1}	Output Data Position0 (T=6.25ns~20ns)	-0.15	0.0	+0.15	ns	
t _{TOP0}	Output Data Position1 (T=6.25ns~20ns)	$\frac{T}{7} - 0.15$	<u>T</u> 7	$\frac{T}{7}$ + 0.15	ns	
t _{TOP6}	Output Data Position2 (T=6.25ns~20ns)	$2\frac{T}{7} - 0.15$	$2\frac{T}{7}$	$2\frac{T}{7} + 0.15$	ns	
t _{TOP5}	Output Data Position3(T=6.25ns~20ns)	$3\frac{T}{7} - 0.15$	$3\frac{T}{7}$	$3\frac{T}{7} + 0.15$	ns	
t _{TOP4}	Output Data Position4 (T=6.25ns~20ns)	$4\frac{T}{7} - 0.15$	4 T 7	$4\frac{T}{7} + 0.15$	ns	
t _{TOP3}	Output Data Position5 (T=6.25ns~20ns)	$5\frac{T}{7} - 0.15$	5 T	$5\frac{T}{7} + 0.15$	ns	
t _{TOP2}	Output Data Position6 (T=6.25ns~20ns)	$6\frac{T}{7} - 0.15$	$6\frac{T}{7}$	$6\frac{T}{7} + 0.15$	ns	
t _{TPLL}	Phase Lock Loop Set			10.0	ms	

AC Timing Diagrams TTL Input

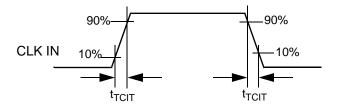


Fig2. CLKIN Transition Time

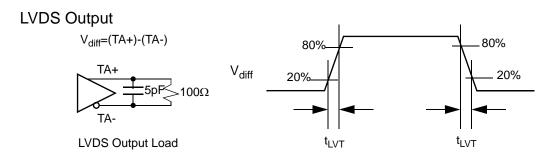
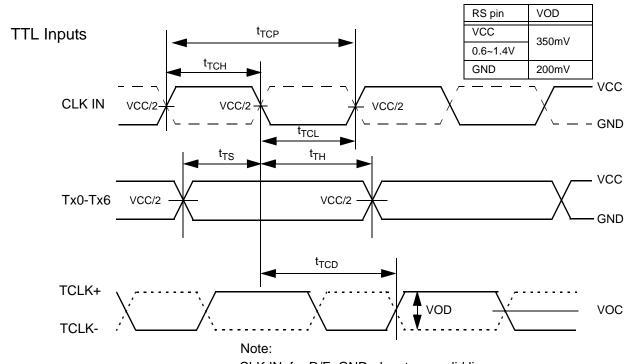


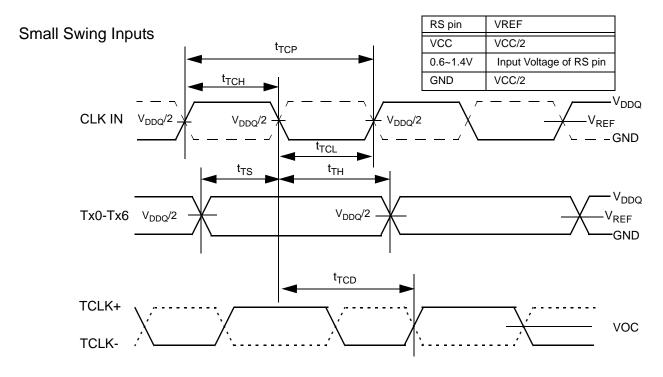
Fig3. LVDS Output Load and Transition Time



AC Timing Diagrams



CLK IN: for R/F=GND, denote as solid line, for R/F=VCC, denote as dashed line. Fig4. CLKIN Period, High/Low Time, Setup/Hold Timing



Note:

CLK IN: for R/F=GND, denote as solid line, for R/F=VCC, denote as dashed line.

Fig5. Small Swing Inputs



AC Timing Diagrams

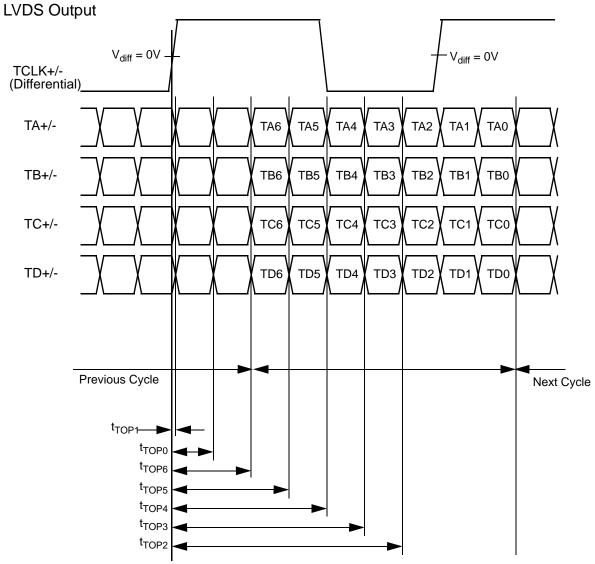
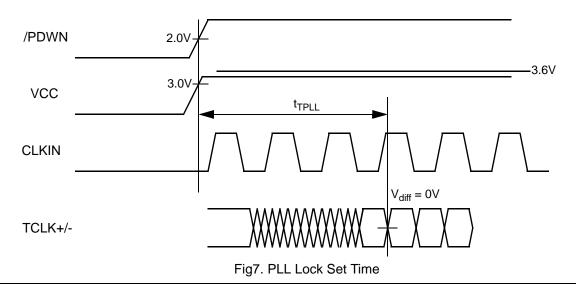


Fig6. LVDS Output Data Position

Phase Lock Loop Set Time





Note

1)Cable Connection and Disconnection

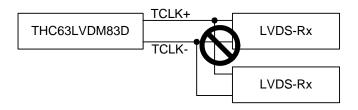
Don't connect and disconnect the LVDS cable, when the power is supplied to the system.

2)GND Connection

Connect the each GND of the PCB which THC63LVDM83D and LVDS-Rx on it. It is better for EMI reduction to place GND cable as close to LVDS cable as possible.

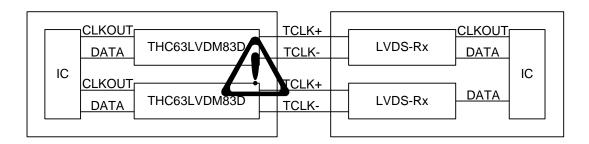
3)Multi Drop Connection

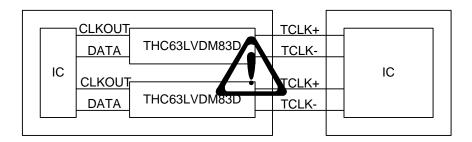
Multi drop connection is not recommended.



4) Asynchronous use

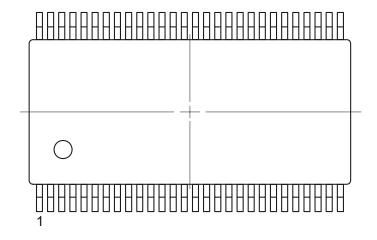
Asynchronous use such as following systems are not recommended.

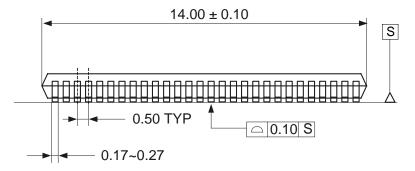


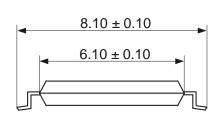


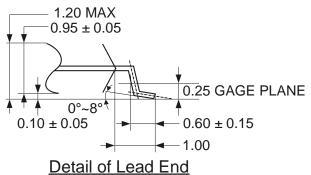


Package









Unit:mm



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